



### Layer Stack Up Detail for: **AMC\_FMC\_Carrier\_v3.PcbDoc**

Layer Name	Gerber Document	Copper Thickness	Dielectric Height	Dielectric Material	Dielectric Constant	Dielectric Type
<b>Top Solder Mask</b>	<b>.GTS</b>		<b>0.0102mm</b>	<b>Solder Resist</b>	<b>3.50</b>	
<b>TOP</b>	<b>.GTL</b>	<b>0.053mm</b>				
<b>G</b>	<b>.GP1</b>	<b>0.018mm</b>	<b>0.1mm</b>	<b>FR-4</b>	<b>4.80</b>	<b>PrePreg</b>
<b>L1</b>	<b>.G1</b>	<b>0.018mm</b>	<b>0.11mm</b>	<b>FR-4</b>	<b>4.80</b>	<b>Core</b>
	<b>.GP2</b>	<b>0.018mm</b>				
<b>L2</b>	<b>.G2</b>	<b>0.018mm</b>	<b>0.1mm</b>	<b>FR-4</b>	<b>4.80</b>	<b>Core</b>
<b>P3</b>	<b>.GP3</b>	<b>0.018mm</b>	<b>0.11mm</b>	<b>FR-4</b>	<b>4.80</b>	<b>PrePreg</b>
<b>L3</b>	<b>.G3</b>	<b>0.018mm</b>	<b>0.1mm</b>	<b>FR-4</b>	<b>4.80</b>	<b>Core</b>
<b>P4</b>	<b>.GP4</b>	<b>0.018mm</b>	<b>0.11mm</b>	<b>FR-4</b>	<b>4.80</b>	<b>PrePreg</b>
<b>GND</b>	<b>.GP5</b>	<b>0.018mm</b>	<b>0.1mm</b>	<b>FR-4</b>	<b>4.80</b>	<b>Core</b>
<b>L5</b>	<b>.G4</b>	<b>0.018mm</b>	<b>0.11mm</b>	<b>FR-4</b>	<b>4.80</b>	<b>Core</b>
<b>P6</b>	<b>.GP6</b>	<b>0.018mm</b>	<b>0.1mm</b>	<b>FR-4</b>	<b>4.80</b>	<b>PrePreg</b>
<b>L6</b>	<b>.G5</b>	<b>0.018mm</b>	<b>0.11mm</b>	<b>FR-4</b>	<b>4.80</b>	<b>Core</b>
<b>BTM</b>	<b>.GP7</b>	<b>0.018mm</b>	<b>0.1mm</b>	<b>FR-4</b>	<b>4.80</b>	<b>PrePreg</b>
	<b>.GBL</b>	<b>0.053mm</b>				
<b>Bottom Solder Mask</b>	<b>.GBS</b>		<b>0.0102mm</b>	<b>Solder Resist</b>	<b>3.50</b>	